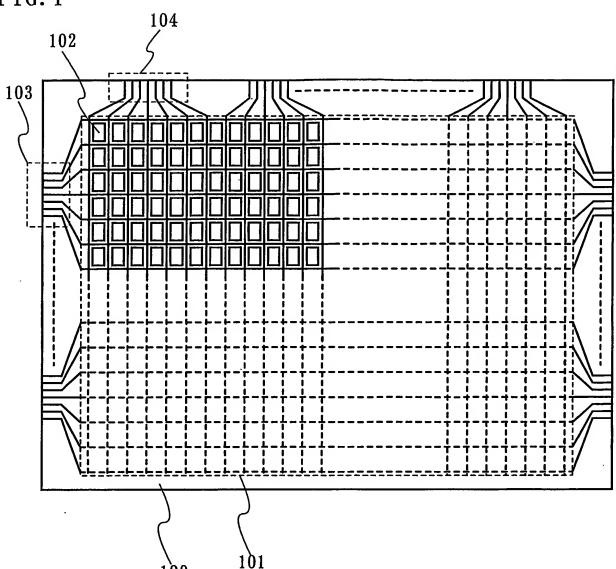
FIG. 1



WO 2005/041310 PCT/JP2004/016169

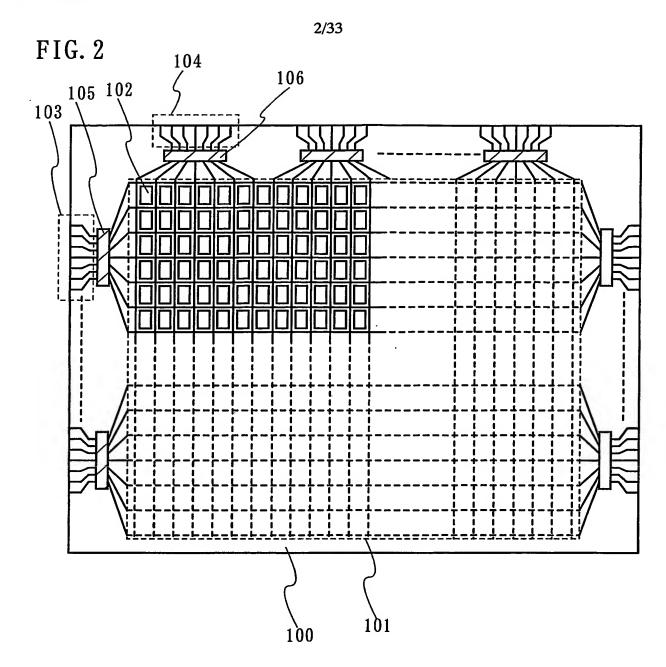
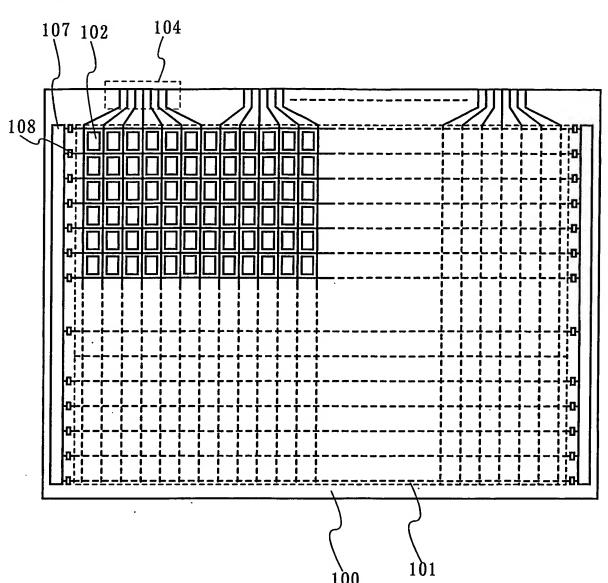


FIG. 3



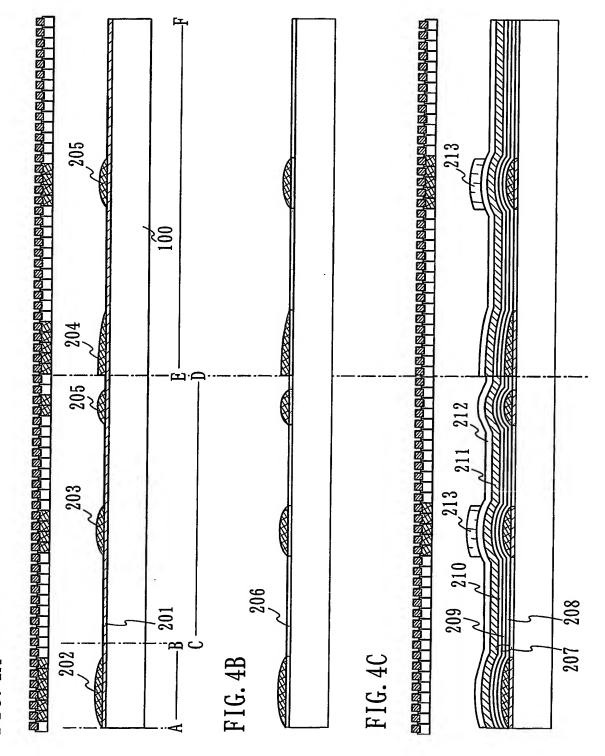
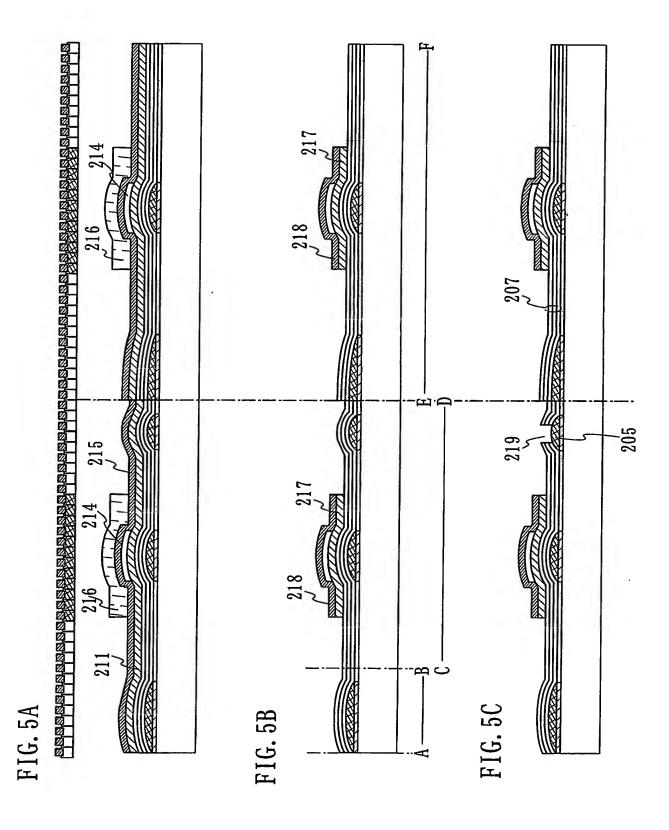
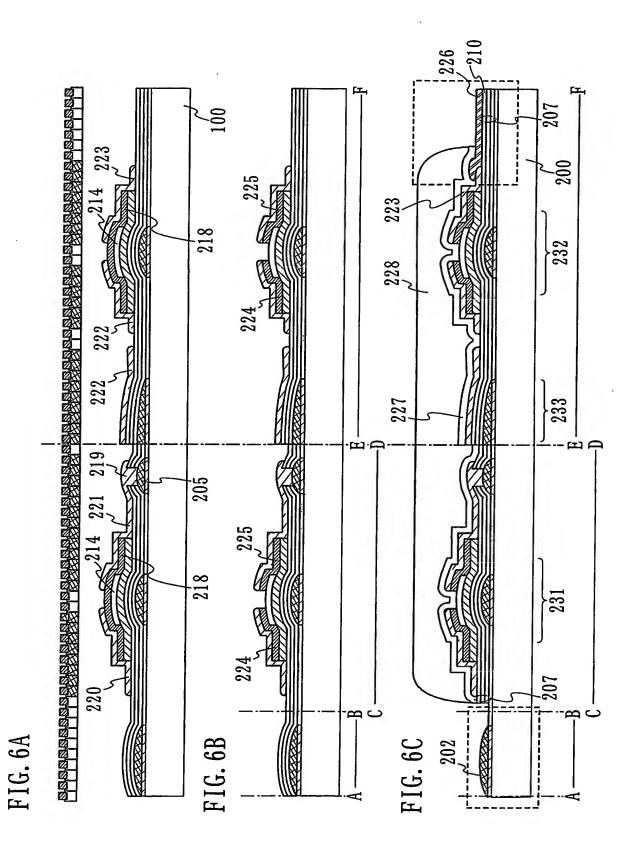
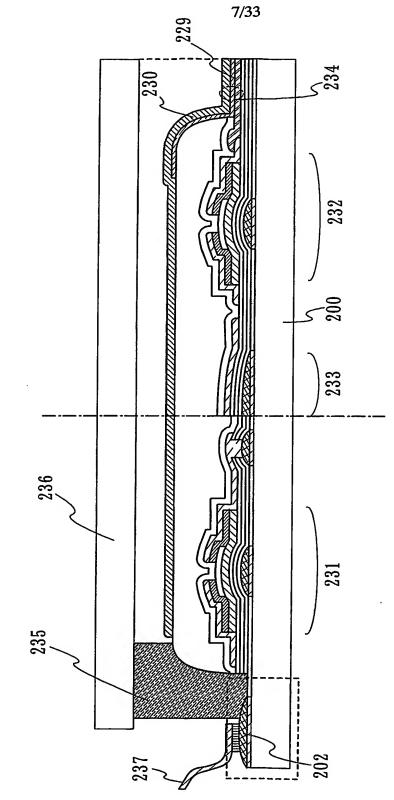


FIG. 4

WO 2005/041310







. TC. 1

WO 2005/041310 PCT/JP2004/016169 8/33

FIG. 8

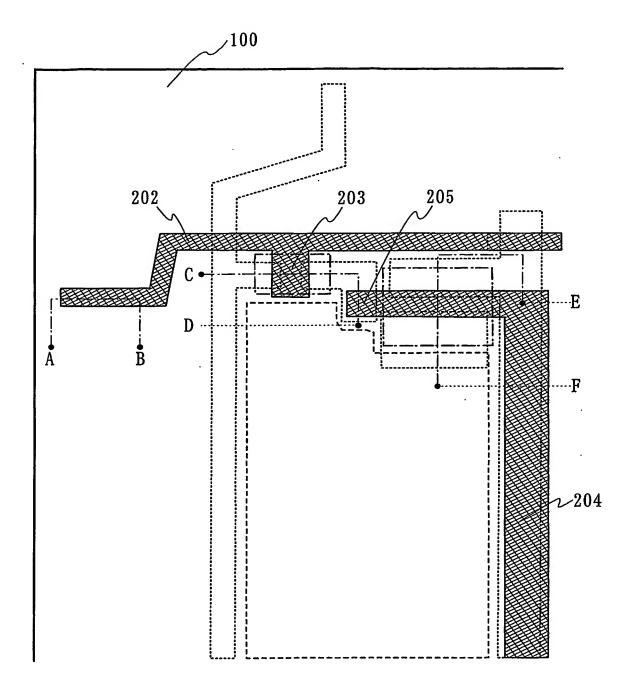
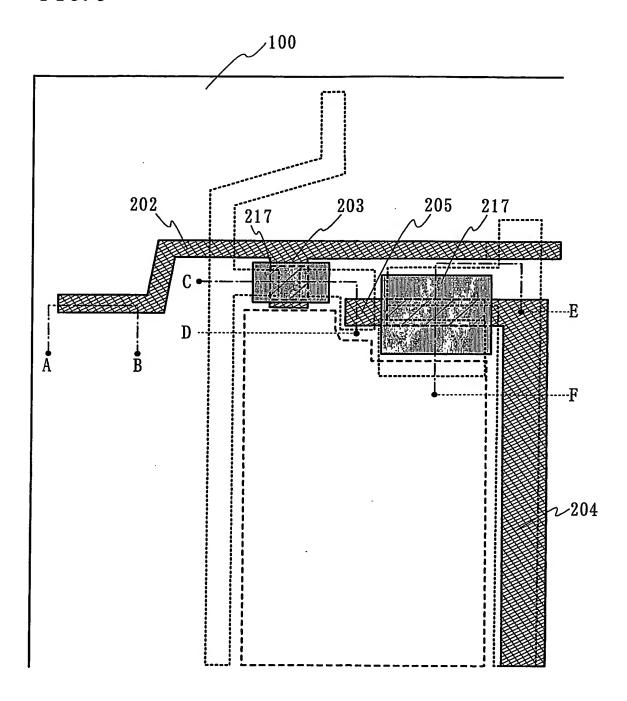


FIG. 9



WO 2005/041310 PCT/JP2004/016169 10/33

FIG. 10

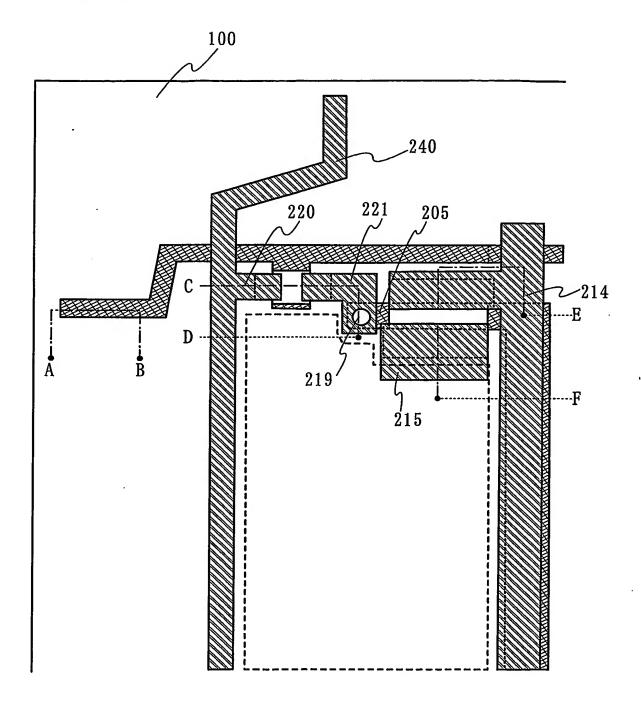
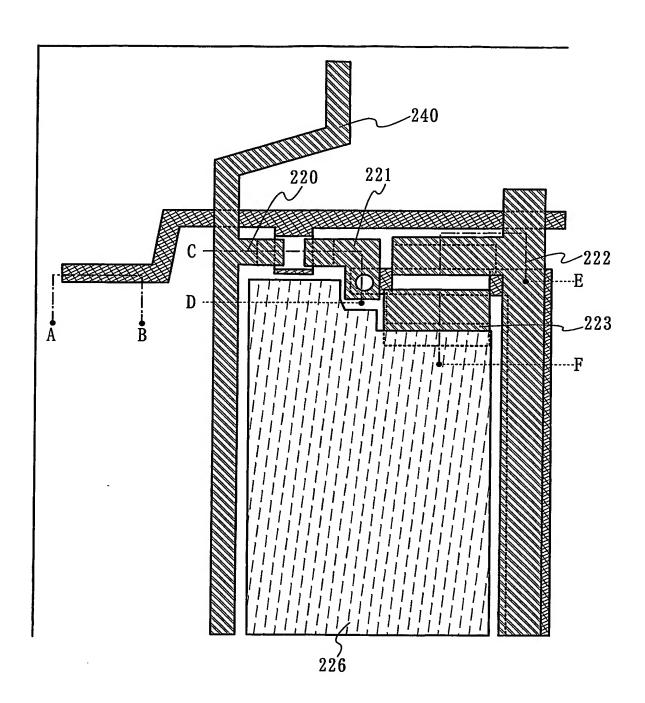
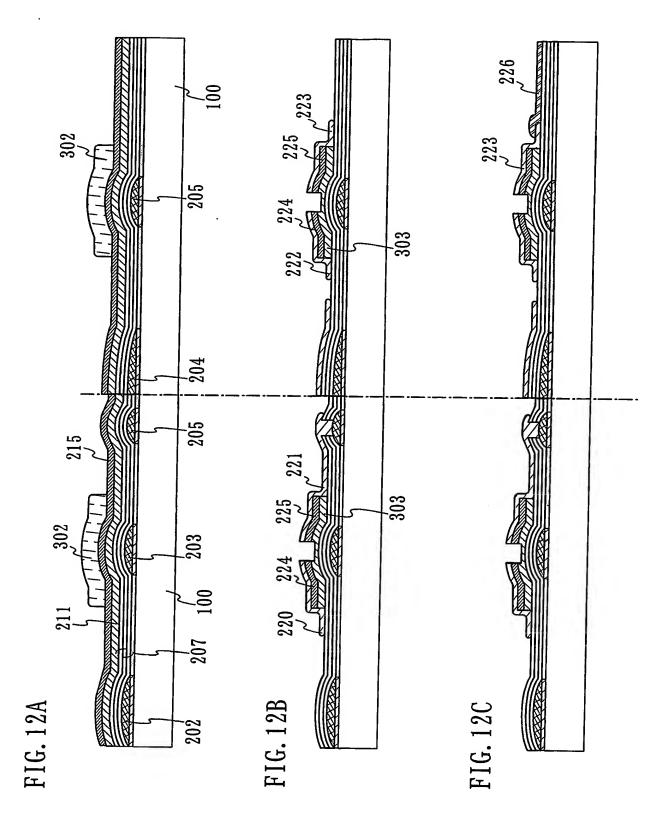


FIG. 11





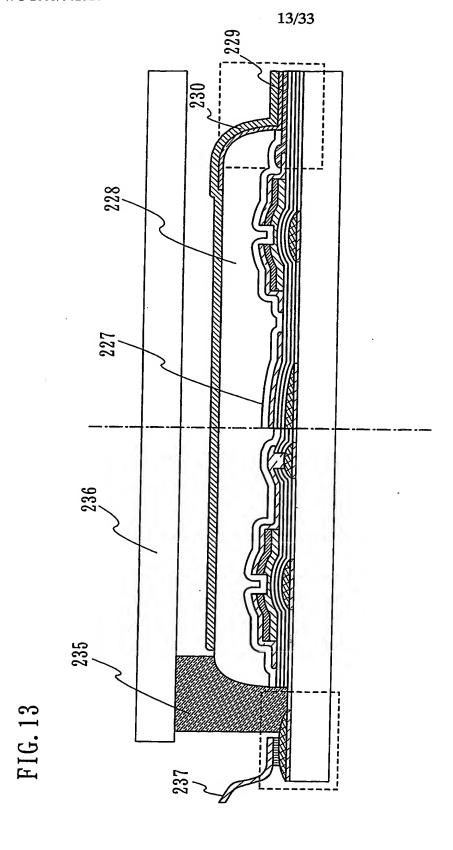


FIG. 14

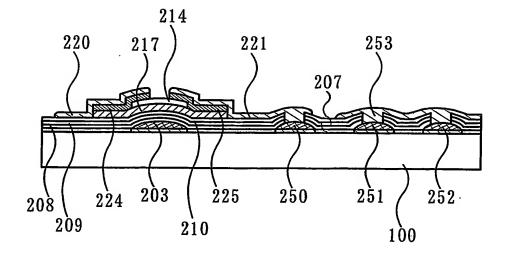


FIG. 15

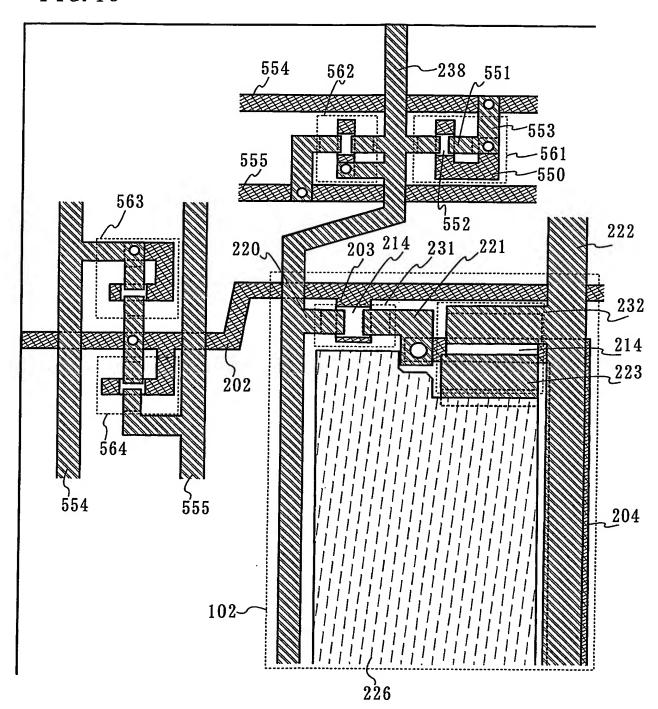
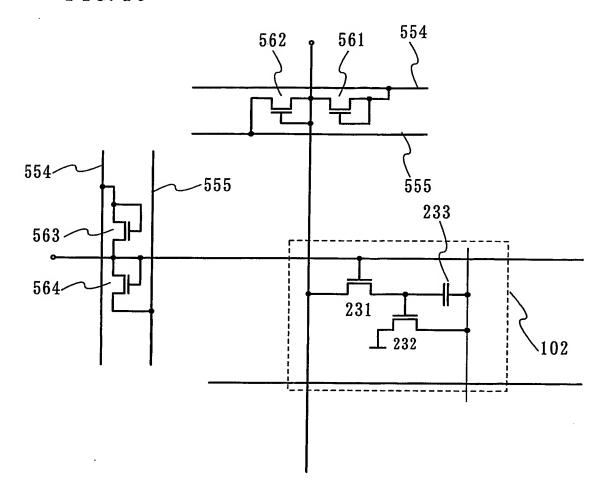
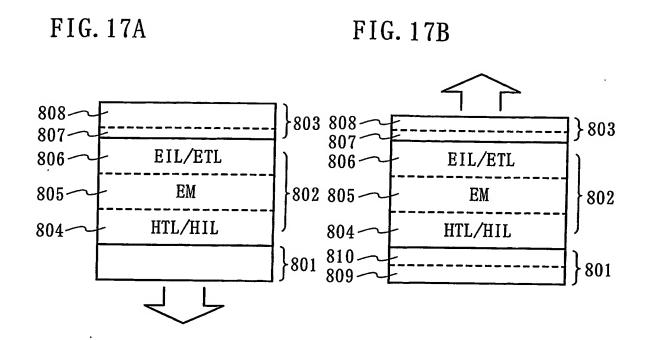


FIG. 16

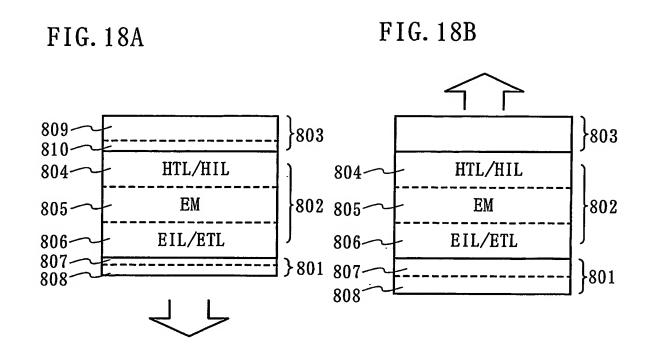


WO 2005/041310 PCT/JP2004/016169

17/33



18/33



20/33

FIG. 20A

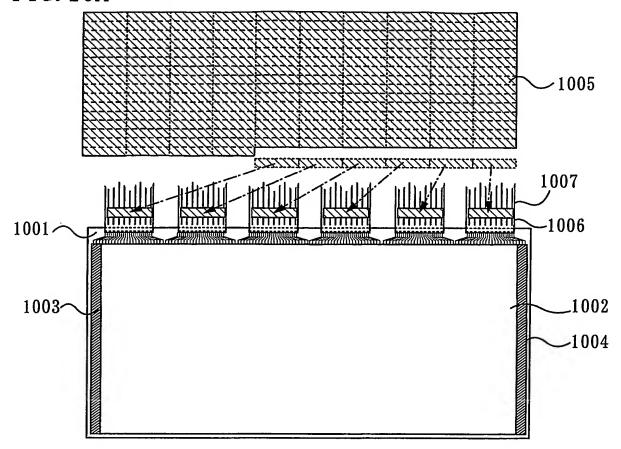
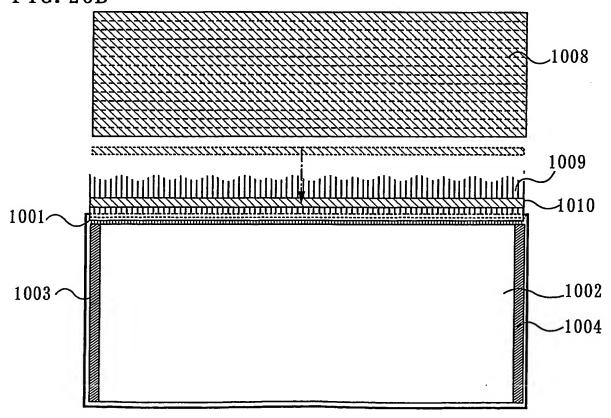


FIG. 20B



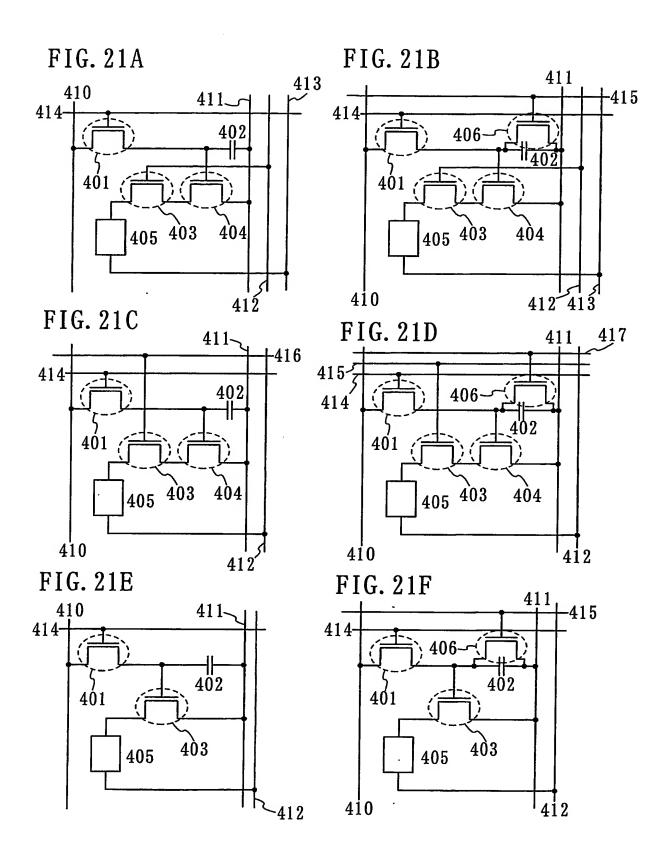


FIG. 22

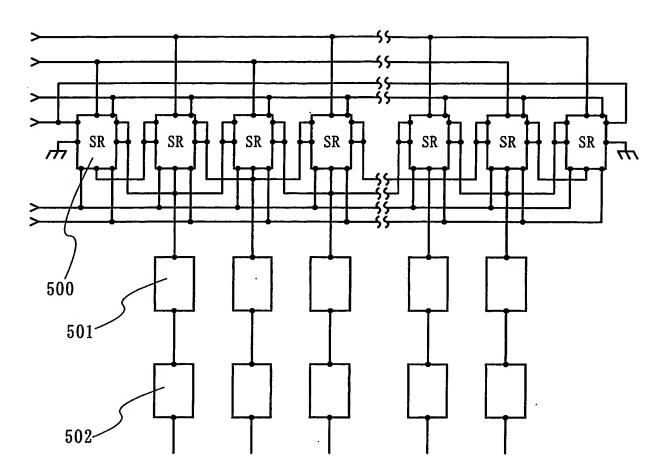


FIG. 23

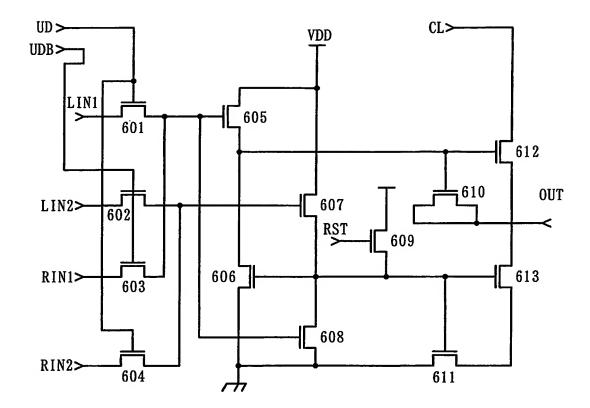


FIG. 24

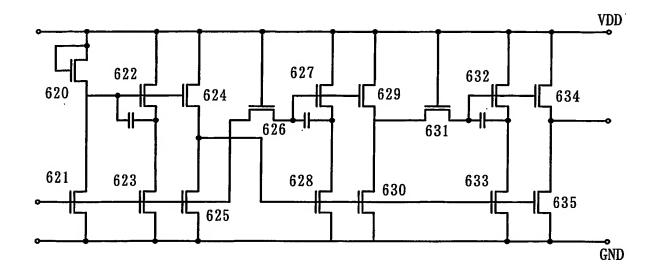
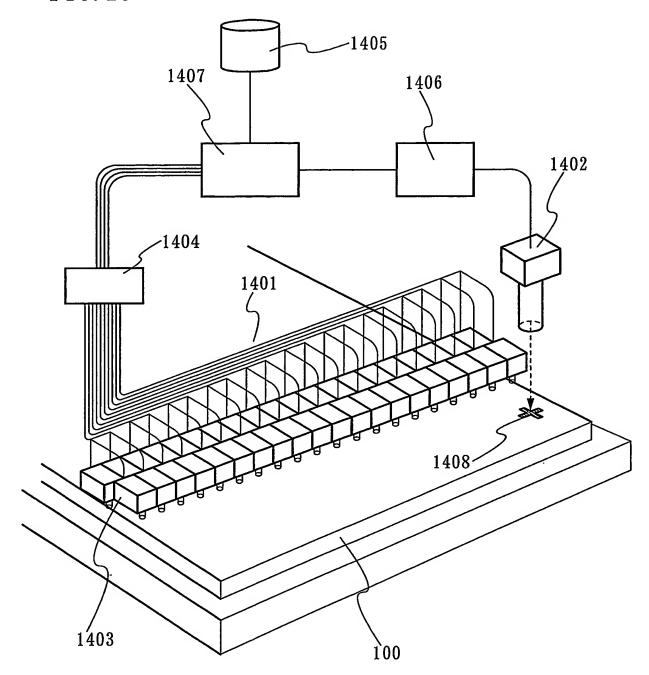


FIG. 25



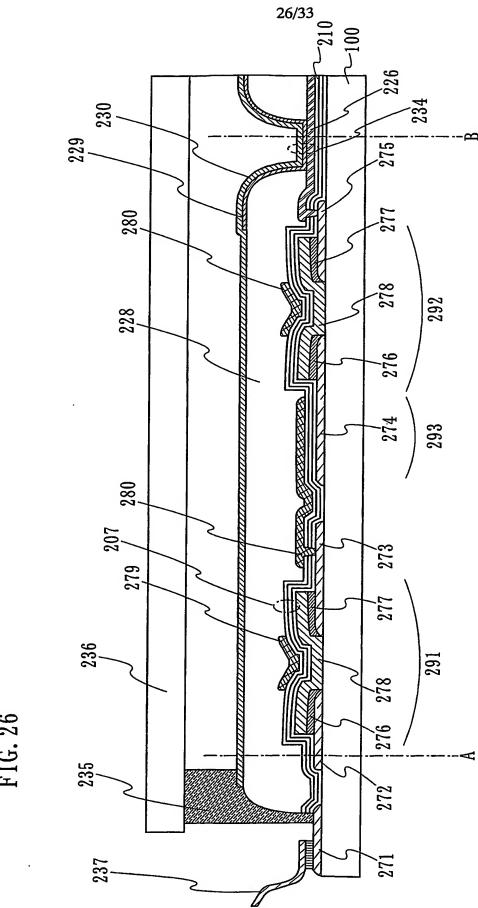


FIG. 27

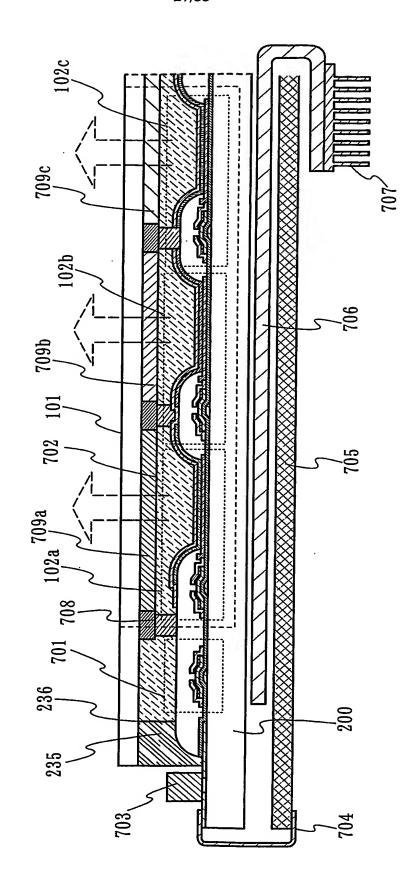


FIG. 28

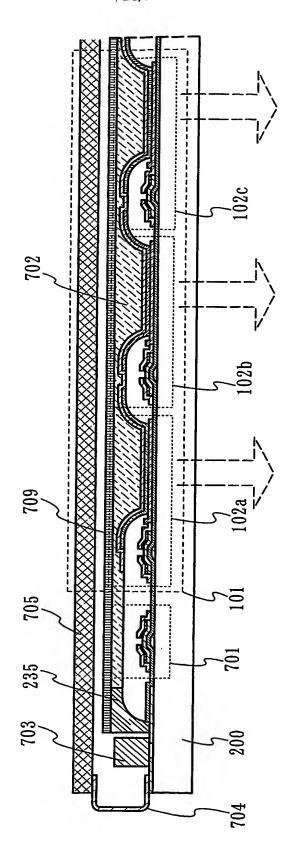
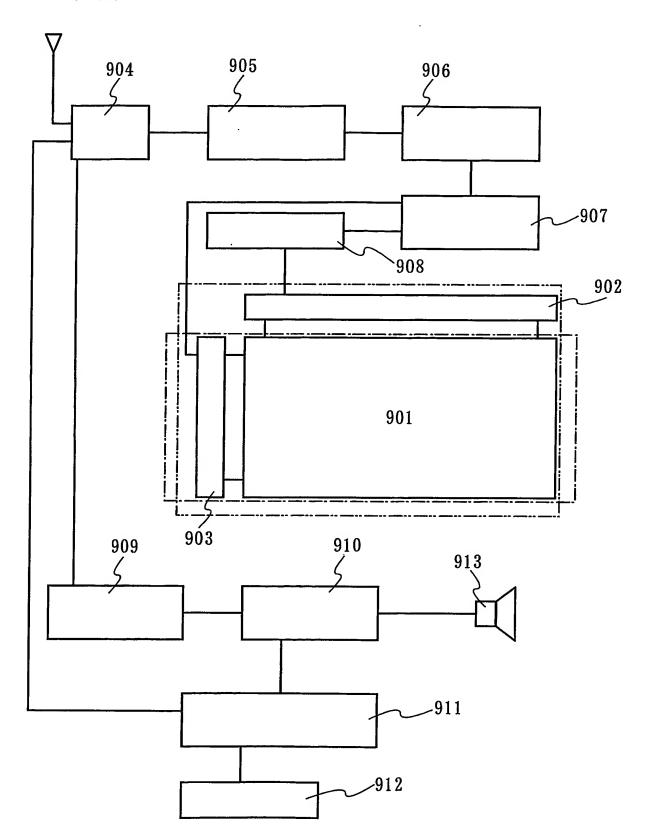


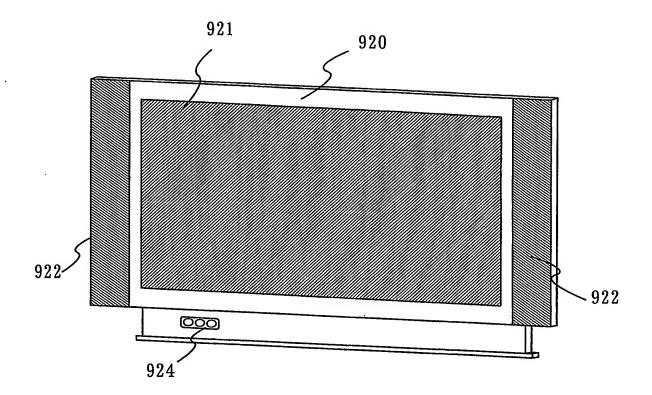
FIG. 29



WO 2005/041310 PCT/JP2004/016169

30/33

FIG. 30



31/33

FIG. 31

